

REMARKS

For convenience in discussing applicants' response to the Action, the headings in the Action are used below. Prior to responding to the Action, applicants note that claim 2 has been amended to include the limitation of claim 17 and claim 17 has been canceled. I.e., amended claim 2 limits the binder of the active material layer of the negative electrode for a rechargeable lithium battery of the present invention to a polyimide binder.

*Double Patenting*

The Office has maintained the provisional double patenting rejections of claims 2-8, 11, 13-15, 17, 20-22 over claims of copending Application Nos. 10/363,039 and 10/673,348. The Office has not repeated the obviousness-type double patenting rejection over the claims of application No. 11/001,192 that was made in prior actions.

Applicants again request that these rejections be held in abeyance pending the determination of allowable subject matter in the present application or one of the related applications.

*Specification*

The disclosure is again objected to because the Office believes that it is not clear how the binder  $\alpha 1$  differs from binder  $\beta 1$  and how the binder  $\alpha 2$  differs from  $\alpha 3$ .

Applicants do not understand the objection to the specification. It is clear from the data in Tables 2 and 6 how the properties of the polyimide binders  $\alpha 1$ ,  $\beta 1$ ,  $\alpha 2$  and  $\alpha 3$  differ from each other. Nothing further is believed to be required.

If the Office maintains the objection to the specification, it is respectfully requested to explain what criterion are used by the Office to object to a specification. I.e., when is the specification of a patent application objectionable and when is it not objectionable.

The Office states that it is unclear how the different properties of the binders were obtained. Why is this a basis for objecting to the specification? Lack of clarity of a specification is an issue relating to enablement under the first paragraph of 35 U.S.C. § 112.

Removal of the objection to the specification is believed to be in order and is respectfully requested.

***Claim Rejections - 35 USC § 112***

Claims 2-8, 13-15, 17, 20-22 are again rejected under 35 U.S.C. 112, first paragraph, for lack of enablement. The Office's position is that it would require undue experimentation for a person of ordinary skill in the art to determine binders that have the properties recited in claim 2. More specifically, as explained

by the Office on page 11 of the Action, "the Examiner's position is that person of ordinary skill in the art would not be able to make the invention without the specifics of the polyamic acids and polyimides [used in the experiments in the present application]."

The issue raised under the enablement requirement of the first paragraph of 35 U.S.C. § 112, as explained in the Action, is whether the specification teaches a person skilled in the art to make and use the claimed invention without undue experimentation. The claimed invention in the present application, according to the claims as amended herein, is a negative electrode for a rechargeable lithium battery which includes a conductive metal foil current collector and an active material layer provided on a surface of the current collector and which comprises a polyimide binder and particles of active material containing silicon and/or a silicon alloy. The electrode is characterized in that the current collector has mechanical properties of at least 80 N/mm<sup>2</sup> tensile strength, at least 30 N/mm<sup>2</sup> proportional limit, at least 1.0 % elongation at break and at least 0.03 % elastic elongation limit and the polyimide binder has mechanical properties of at least 50 N/mm<sup>2</sup> tensile strength, at least 10 % elongation at break, at least  $2.5 \times 10^{-3}$  J/mm<sup>3</sup> strain energy density and up to 10,000 N/mm<sup>2</sup> elastic modulus. Applicants have discovered that a binder

having the properties recited in the claims can accommodate a high stress applied thereto as a result of volumetric expansion and shrinkage of the active material particles of the active material layer, and can prevents breakage of the binder during a charge-discharge reaction. The binder having the required properties is itself not novel.

Theefore, the specific issue raised by the instant rejection under the first paragraph of 35 U.S.C. § 112 is whether a person of ordinary skill in the art could determine or obtain polyimides useful as the binder in the active material layer of the negative electrode of the present invention, i.e., polyimides having the properties recited in the claims, without undue experimentation.

Applicants respectfully submit that polyimides, polyamic acids and techniques for preparing polyimides from polyamic acids or techniques for preparing polyimides according to other procedures are so well known and have been known for such a long time that a person of ordinary skill in the art could make or otherwise obtain suitable polyimides without experimentation or, at least, without excessive experimentation. Moreover, suitable polyimides are also commercially available.

For the same reasons, the specifics of the polyamic acids that were used in the experiments in the present application are not

required because these are not the only polyimides that can be used to practice the invention. In this regard, it is noted that the Office appears to believe that suitable polyimides can only be obtained by the treatment conditions used in the experiments in the examples in the present application or that only the specific polyimides used in these experiments can be used to practice the present invention. However, such belief is not correct and the Office has not identified any teaching in the specification or in the prior art to support such belief.

As examples of evidence of the fact that polyimides are well-known in the art and that are suitable for use in the present invention can be determined or obtained without undue experimentation, applicants note the term "polyimides" appears in the title of 318 United States patents. The term "polyimide" appears in the title of 1336 United States patents. The terms "polyimide(s)", "binder", "lithium" and "battery" developed 25,100 "hits" in a Google search conducted October 9, 2007. The terms "polyimide", "binders", "lithium" and "battery" developed 31,700 "hits". The terms "polyimide", "binders", "lithium" and "batteries" developed 37,800 "hits".

Applicants are also submitting herewith a document and English translation of pertinent portions thereof identifying

characteristics of commercially available binders. The mechanical properties of the polyimide binder recited in claim 2 of the present application correspond to the following items listed in Table 4.1-2:

- Tensile Strength: Tensile Strength (25°C);
- Elongation at Break: Coefficient of Extension (25°C)  
and
- Elastic Modulus: Coefficient of Elasticity (25°C).

The relationship between the units  $\text{kg/mm}^2$  and  $\text{N/mm}^2$  is  $9.80665 \text{ kg/mm}^2 = \text{N/mm}^2$ .

Referring to Table 4.1-2 (and converting to the relevant units), it is seen that the mechanical properties of "Upilex R" and "Upilex S" of Ube Machinery are as follows:

|                                      | Upilex R | Upilex S |
|--------------------------------------|----------|----------|
| Tensile Strength ( $\text{N/mm}^2$ ) | 245      | 392      |
| Elongation at Break (%)              | 130      | 30       |
| Elastic Modulus ( $\text{N/mm}^2$ )  | 3724     | 8820     |

These properties correspond closely to those of binders  $\alpha 1$  and  $\beta 1$  in the experiments in the present application. The enclosed information is evidence of the commercial availability of suitable polyimide binders.

For the above reasons applicants submit that polyimide binders suitable for use in the present invention can be obtained without undue experimentation and that the application complies with the requirements of 35 U.S.C. § 112, first paragraph. Removal of the 35 U.S.C. 112, first paragraph, rejection of the claims is believed to be in order and is respectfully requested.

***Claim Rejections - 35 USC § 103***

Claims 2-8, 13-15, 20-22 are rejected under 35 U.S.C. 103(a) as obvious over Nobufumi (JP 2000-012088) in view of Solomon (U.S. Patent No. 4,927,514), as evidenced by the glass transition point and melting point of polytetrafluoroethylene, retrieved by the Office on March 23, 2007, from the Internet at [www.scientificpolymer.com/catalog/description.asp?QproductCode=203](http://www.scientificpolymer.com/catalog/description.asp?QproductCode=203). Claim 17 is rejected under 35 U.S.C. 103(a) as obvious over Nobufumi in view of Solomon as evidenced by the glass transition point and melting point of polytetrafluoroethylene as applied to claim 2, further in view of Gan (U.S. 2002/0094480).

As noted above, claim 2 has been amended to include the limitation of claim 17.

Applicants understand the position of the Office to be that it would be obvious in view of Nobufumi and Solomon to heat treat a

negative electrode of Nobufumi, which uses PTFE as a binder, at a temperature of 280 to 350°C as disclosed in Solomon and that this temperature is higher than a glass transition temperature and lower than a decomposition temperature of the PTFE.

Applicants respectfully submit that a person of ordinary skill in the art would not be motivated to apply the teachings of Solomon relating to a platinum black air cathode to the negative electrode of the lithium secondary battery of Nobufumi. The properties desired of the platinum black air cathode for an electrolytic cell for producing ozone of Solomon in which an active layer comprising platinum black and PTFE are deposited on a support layer comprising a mixture of particulate carbon with hydrophobic polymer are not the same properties required for the negative electrode for a nonaqueous secondary battery of Nobufumi in which an active layer comprising a silicon-containing material, carbon and a binder are deposited on an electrolytic copper foil. Additionally, the Office has failed to satisfy its burden of providing proper evidence or reasoning showing that the electrodes of the respective references are so closely related that the conditions used to prepare the platinum black air cathode of Solomon would have been reasonably expected to have the same effects when applied to the negative



electrode of Nobufumi. Two references are not combinable merely because they both disclose negative electrodes.

Moreover, the Office has not shown how the proposed combination of Nobufumi and Solomon would result in a polyimide having the properties recited in claim 2. A position that the sintering conditions of Solomon, if applied to a negative electrode of Nobufumi where the binder is polyimide, would inherently result in a polyimide having the properties recited in claim 2 is inconsistent with the position of the Office taken in the 35 U.S.C. § 112, first paragraph, rejection.

For the above reasons, the Office has not shown a prima facie case of obviousness under 35 U.S.C. § 103(a) and removal of the 35 U.S.C. 103(a) rejections of the claims is also in order and is respectfully requested.

The foregoing is believed to be a complete and proper response to the Office Action dated June 7, 2007, and is believed to place this application in condition for allowance. If, however, minor issues remain that can be resolved by means of a telephone interview, the Examiner is respectfully requested to contact the undersigned attorney at the telephone number indicated below.

PATENT APPLN. NO. 11/001,192  
RESPONSE UNDER 37 C.F.R. §1.111

**PATENT  
NON-FINAL**

In the event that this paper is not considered to be timely filed, applicants hereby petition for an appropriate extension of time. The fee for any such extension may be charged to our Deposit Account No. 111833.

In the event any additional fees are required, please also charge our Deposit Account No. 111833.

Respectfully submitted,

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Attachment: Characteristics of commercially available binders  
and English translation of Table 4.1-2

## 4. ポリイミドの樹脂形状

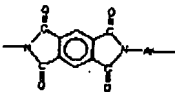
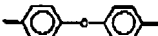

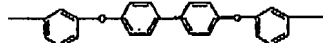
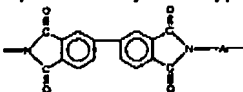


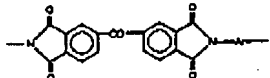
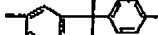
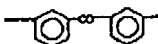
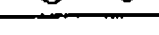
ポリイミドは多くの製品に使用されており、使用される段階での樹脂形状也多岐にわたる。中でも多いのはフィルムとワニスであるが、用途によりあらゆる樹脂形状のポリイミドが開発されている。

### 4. 1 フィルム

#### A. 代表的なポリイミドフィルム

ポリイミドフィルムの約70%はFPC(Flexible Printed Circuit Board)に使用され、残りが車両用モーターや産業用モーターのコイルの絶縁用フィルム、宇宙航空機器用や超電導機器用の電線被覆用フィルムなどに使用されている。近年、半導体実装用のTAB(Tape Automated Bonding)としても盛んに使用されるようになり一段と需要が伸びはじめた。代表的なポリイミドフィルムの分子構造とその商品名を表4.1-1に示す<sup>1)</sup>。

表4.1-1 代表的なポリイミドフィルムの分子構造とその商品名<sup>1)</sup>

| Molecular structure of polyimide film  | Ar  | T <sub>g</sub> (°C) | Trade name | Maker               |
|--|---|---------------------|------------|---------------------|
| Pyromellitic acid type<br>                  |   | 420                 | KAPTON     | Toray/Du Pont       |
|  |  | 330                 | APICAL     | Kaneka              |
|  |  | 250                 | NOVAX      | Mitsubishi Chemical |
| Biphenyl tetra carboxylic acid type<br>     |  | 500                 | REGURUS    | Mitsui Toatsu       |
|  |  | 290                 | UPILEX S   | Ube                 |
| Benzophenone tetra carboxylic acid type<br> |  | 320                 | UPILEX R   | Ube                 |
|  |  | 280                 | XU216      | Ciba-Geigy          |
|  |  |                     | LARC-TPI   | NASA                |

「Kapton」はDu Pont社により開発された世界最初のポリイミドフィルムであり、日本では東レ・デュポンが生産している。最近、寸法安定性の良いポリイミドフィルム「Kapton V.K.E」を上市<sup>2)</sup>した。「Apical」は「Kapton」の特許が切れたと同時に鐘淵化学工業が生産を始めたもので、分子構造はほぼ同じである。最近、寸法安定性の良いポリイミドフィルム「Apical NPI」を上市<sup>3)</sup>した。「Upilex」は宇部興産が独自開発したポリイミドフィルムで、「Kapton」とは分子構造が異なり、強度や弾性率は「Kapton」の2倍以上ある。このためフィルム厚みを半分にしても同等の性能が出せるため、電子部品材料の軽量化効果が大きく、特にTAB用途に需要が伸びている。「Novax」は三菱化学が開発したもので、主として垂直磁気記録の媒体用に使用

(1)

されている。「Regulus」は三井東圧化学(三井化学)が開発した熱可塑性のポリイミドフィルムで、各種回路基板などに使用されている<sup>4) 5) 6)</sup>。ポリイミドフィルムの特性を、各種耐熱性フィルムのそれと比較して表4.1-2に示す<sup>6) 7)</sup>。

表4.1-2 高耐熱性フィルムの特性比較<sup>6) 7)</sup>

| 項目                | 単位                       | デュボン      | 宇部興産       |            | 旭硝子                | 三井化成               |            | 日東電工       | 三菱樹脂      | 東都石化                  | 三井化学   | 住友化学  | 三井化学    |
|-------------------|--------------------------|-----------|------------|------------|--------------------|--------------------|------------|------------|-----------|-----------------------|--------|-------|---------|
|                   |                          | カプトン      | ユービレックス    |            | アビカル               | ノバックス              | ニットミッド U   |            | スベリオ UT   | PAA                   | レグルス   | スカタセル | ビクトレックス |
|                   |                          | Hタイプ      | R          | S          | AH                 |                    | Film U     | Film N     | (PEI)     | (ポリイミド)               |        | (PES) | (PEEK)  |
| ガラス転移温度           | ℃                        | (400)     | 285        | >500       | (400)              | 350                | 290        | なし         | 216       | 290                   | 250    | 225   | 143     |
| 収縮率(250℃, 30 min) | %                        | 0.3       | 2h 0.18    | 2h 0.07    | 0.15               | 2h 0.16            | 0.11       | 0.10       | 230℃ 0.2  | 260℃ 0.35             |        |       |         |
| 膨張率               | $\times 10^{-3}$ cm/cm/℃ | 2.0       | 1.5        | 0.8        | 2.1                | 1                  | 2.0        | 2.3        | 4.9       | 4.2                   |        |       |         |
| 比熱                | cal/g/℃                  | 0.261     | 0.26       | 0.27       | 0.26               |                    |            |            | 0.3~0.32  |                       |        |       |         |
| 引張強度 (25℃)        | kg/mm <sup>2</sup>       | 17.6      | 25         | 40         | 21.5               | 33                 | 22.0       | 20.0       | 11        | 11.2                  | 12     | 9     | 13      |
| " (200℃)          | "                        | 12.0      | 20         | 300℃ 22    | 12.0               | 19                 |            |            |           | 3.9                   |        |       |         |
| %伸長時応力 (25℃)      | "                        | 9.1       | 12         | 26         | 10                 | 21                 | 12.0       | 7.5        |           |                       |        |       |         |
| " (200℃)          | "                        | 6.0       | 6          | 300℃ 9     | 6                  | 10                 |            |            |           |                       |        |       |         |
| 伸び率 (25℃)         | %                        | 70        | 130        | 30         | 70                 | 40                 | 75         | 75         | 100       | 10                    | 110    | 100   | 100     |
| " (200℃)          | "                        | 90        | 190        | 300℃ 48    | 92                 | 55                 |            |            |           | 5                     |        |       |         |
| 引張弾性率 (25℃)       | kg/mm <sup>2</sup>       | 302       | 380        | 900        | 350                | 700                | 310        | 280        | 300       | 211                   | 310    | 260   | 300     |
| " (200℃)          | "                        | 183       | 210        | 300℃ 350   | 182                | 390                |            |            |           | 141                   |        |       |         |
| 引張変位(エルゲンドルフ)     | g/mm <sup>2</sup>        | 320       | 750        | 330        | 320                | 500                |            |            |           |                       | 2100   | 900   | 1400    |
| 引張抵抗(グレーブ)        | kg/mm <sup>2</sup>       | 20.1      | 40         | 23         | 19                 |                    | 20         | 20         | 18        | 20                    |        |       |         |
| 摩擦係数(フィルム/フィルム)   |                          | 0.42      | 0.4        | 0.4        | 0.4                | 1                  |            |            |           | 0.33                  |        |       |         |
| 絶縁耐力 (25℃)        | kV/mm                    | 276       | 276        | 268        | 275                | 296                | 320        | 320        |           | 220                   | 280    | 260   | 250     |
| " (200℃)          | "                        | 220       | 280        | 268        | 210                | 250                |            |            |           |                       |        |       |         |
| 電率 (1kHz)         |                          | 3.5       | 3.5        | 3.5        | 3.0                | 2.98               | 34         | 3.3        | 3.5       | 3.4                   | 3.1    | 3.7   | 3.1     |
| 電正接 (1kHz)        |                          | 0.003     | 0.0014     | 0.0013     | 0.0021             | 0.0007             | 0.0020     | 0.0020     | 0.0013    | 0.0040                | 0.0009 | 0.014 | 0.0047  |
| 体抵抗率              | $\Omega \cdot \text{cm}$ | $10^{16}$ | $10^{17}$  | $10^{17}$  | $5 \times 10^{17}$ | $4 \times 10^{18}$ | $10^{17}$  | $10^{17}$  | $10^{17}$ | $5 \times 10^{18}$    |        |       |         |
| 面抵抗率              | $\Omega$                 | $10^{16}$ | $>10^{16}$ | $>10^{16}$ | $1 \times 10^{16}$ | $5 \times 10^{16}$ | $>10^{16}$ | $>10^{16}$ |           |                       |        |       |         |
| 密度                | g/mm <sup>3</sup>        | 1.42      | 1.39       | 1.47       | 1.42               | 1.38               | 1.40       | 1.42       | 1.27      | 1.36                  | 1.33   | 1.37  | 1.30    |
| 折率                |                          | 1.78      |            |            |                    | 1.75               |            |            |           |                       |        |       |         |
| 吸水率 (24h)         | %                        | 2.9       | 1.3        | 1.2        | 2.7                | 48h 2.4            | 1.3        | 2.1        | 0.25      | 125 $\mu\text{m}$ 2.8 |        |       |         |
| 湿率 (50%/RH)       | "                        | 1.3       | 1.0        | 0.8        | 1.2                | 0.98               |            |            |           |                       | 0.24   | 0.53  | 0.13    |
| 膨張率 (cm/cm/% RH)  | $\times 10^{-3}$         | 2.2       | 2.2        | 1.1        | 2.1                | 1                  | 2.0        | 2.2        |           | 4.7                   |        |       |         |

ポリイミドフィルムは優れた機械特性を有している。中でも、「Upilex」の引張強度は40kg/mm<sup>2</sup>と「Kapton」の約2倍で、軟鋼並の強度である。「Upilex」の引張弾性率も900kg/mm<sup>2</sup>と「Kapton」の約3倍で、フィルム厚みを半分にしても十分な腰を有している。ポリイミドフィルムの熱的特性は特に優れている。図4.1-1に、各種の耐熱性樹脂の重量減少率と温度の関係を示す<sup>8)</sup>。「Upilex」が最高の耐熱性を示し、熱分解開始温度は520℃以上と高く、熱膨張係数は15ppmと小さい。

ポリイミドフィルムの電気的特性も優れており、なかでも「Upilex」の誘電正接は低く、広い温度範囲、広い周波数域で安定である。化学的特性でも「Upilex」は耐薬品性、耐アルカリ性に優れている。吸湿特性<sup>9)</sup>でも「Upilex」は優れており、イミド環を持っているにも拘わらず吸湿は小さく、吸湿による寸法変化はPET(Polyethylene terephthalate)並に小さい。

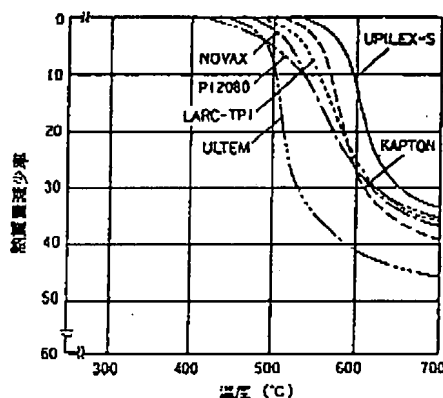


図4.1-1 各種の耐熱性樹脂の重量減少率と温度の関係<sup>8)</sup>

表4.4-1 主なポリイミド成形品の特性<sup>1)</sup>

| 用 途   | 単 位  | デュポン   | 日東電工   | 三 菱 化 成   | 体五化学   | EPL   | 東芝ケミカル  | 日本ポリイミド  | T1 ポリマー  |   |   | 測定法<br>(基準)<br>ASTM                   |
|-------|--|--|--|---|--|---|---|--|--|---|---|---------------------------------------|
|       |  | ベスベル<br>SP-1   | ベスベル M-100   | トーロン<br>4203 L  | PI-2080  | スミカ PAI<br>M7000  | ウルテム<br>1000  | イミグロイ<br>KIR-30  | 5514   | CF  | CF  |                                       |
|       |  | ナチュラル  | ナチュラル  | TIO <sub>2</sub> 3%<br>PTFE 0.5%  | ナチュラル  | ナチュラル   | ナチュラル   | ナチュラル  | GP50%  | CF  | CF  |                                       |
| 熱的性質  | ガラス転位温度<br>熱膨張率<br>熱伝導率<br>比 熱   | ℃<br>×10 <sup>-3</sup> /cm/cm・℃<br>kcal/m・h・℃<br>kcal/kg・℃   | (400)<br>4.4<br>0.295<br>0.27  | 5.5<br>0.345<br>0.33  | (260)<br>4.0<br>0.33   | 310<br>5.0<br>4.6<br>0.367  | 217<br>5.5<br>0.19  | 7  | 1.3<br>0.31  | 2.5<br>0.3  | 2.6<br>0.3  | D690<br>D621                          |
| 機械的性質 | 密度<br>引張強さ (23℃)<br>引張強さ (260℃)<br>伸び率 (23℃)<br>伸び率 (260℃)<br>曲げ強さ (23℃)<br>曲げ強さ (260℃)<br>曲げ弾性率 (23℃)<br>曲げ弾性率 (260℃)<br>圧縮強さ<br>圧縮弾性率<br>断面積 (アイゾット、ノッチ付き) | (18.6 kg/cm <sup>3</sup> )<br>kg/cm <sup>2</sup><br>kg/cm <sup>2</sup><br>%<br>%<br>kg/cm <sup>2</sup><br>kg/cm <sup>2</sup><br>×10 <sup>3</sup> kg/cm <sup>2</sup><br>kg/cm <sup>2</sup><br>×10 <sup>3</sup> kg/cm <sup>2</sup><br>kg/cm/cm | 875<br>420<br>7.5<br>7.0<br>1,330<br>770<br>31.5<br>17.5<br>10% (ノッチ) 1,351<br>24.5<br>8.1       | 990<br>250℃ 570<br>7.3<br>250℃ 7.0<br>1,400<br>250℃ 18.1<br>31.1<br>18.1<br>1,950<br>24.2 | 1,300<br>530<br>12<br>22<br>2,160<br>760<br>31.1<br>30.3<br>>3,100<br>21.6<br>13.8 | 1,200<br>280℃ 310<br>10<br>22<br>1,970<br>230℃ 350<br>35.2<br>290℃ 11.3<br>2,000<br>20.7<br>7.9 | 950<br>640<br>8.5<br>12.5<br>1,600<br>900<br>42<br>25<br>2,600<br>27<br>2.0 | 1,070<br>60<br>60<br>1,480<br>900<br>33.7<br>35.7<br>2,000<br>1,430<br>5 | 450<br>250℃ 400<br>1,500<br>250℃ 1,250<br>140<br>200℃ 105<br>2,400<br>30 | 850<br>250℃ 550<br>1.2<br>1,400<br>250℃ 900<br>103<br>250℃ 70<br>2,200<br>4 | 670<br>250℃ 400<br>0.5<br>1,400<br>250℃ 720<br>66<br>2,700<br>2 | D1706<br>D790<br>D790<br>D695<br>D256 |
| 電気的性質 | 誘電率 (1 MHz)<br>誘電正接 (1 MHz)<br>絶縁耐力<br>体積抵抗率<br>表面抵抗率  | kV/mm<br>kV/mm<br>Ω・cm<br>Ω  | 3.55<br>0.0034<br>23<br>10 <sup>14</sup> ~10 <sup>15</sup><br>10 <sup>14</sup> ~10 <sup>15</sup> | 1 kHz 3.5<br>0.002<br>23<br>1.4×10 <sup>14</sup><br>10 <sup>14</sup>                      | 3.3<br>0.009<br>23.5<br>10 <sup>14</sup><br>10 <sup>14</sup>                       | 1 kHz 3.42<br>0.0018<br>28<br>10 <sup>14</sup><br>10 <sup>14</sup>                              | 1 kHz 3.15<br>0.0013<br>28<br>10 <sup>14</sup><br>10 <sup>14</sup>          | 3.57<br>0.009<br>0.009<br>5×10 <sup>14</sup><br>1.30                     | 4.5<br>0.017<br>18<br>10 <sup>14</sup><br>1.7                            | 3.9<br>0.009<br>20<br>10 <sup>14</sup><br>1.73                              | 4.2<br>0.006<br>20<br>10 <sup>14</sup><br>1.62                  | D150<br>D149<br>D257<br>D785          |
| その他   | 硬度<br>線膨張率 (ロッキングスケール)<br>線膨率 (24h)  | g/cm <sup>3</sup><br>%<br>%  | 1.43<br>E 45~48<br>M 92~102<br>0.24  | 1.41<br>E 91<br>0.28  | 1.41<br>E 99<br>0.21   | 1.41<br>M 117<br>0.25   | 1.27<br>M 109<br>0.25   | 1.30<br>M 118<br>0.5   | 1.7<br>M 120<br>0.3  | 1.73<br>M 119<br>0.40   | 1.62<br>M 119<br>0.40   | D785<br>D570                          |

## B. 新しいポリイミド成形材料

デュポン社はピロメリット酸二無水物と4,4'-ジアミノジフェニルエーテルとからなるポリイミド成形材料「Vespel」を生産している。「Vespel」には、従来から販売している標準品の「SP-1」と新しく開発した「SCP-5000」がある。

「Vespel」の特徴は、①耐熱性が高く、大気中280℃、不活性ガス中400℃での連続使用が可能である、②引っ張り強度はPTFEの3倍、荷重変形はPTFEの1/70と、強靱で割れがたい、③耐摩耗性が優れ、PTFEよりも摩耗係数、摩耗量とも小さい、④耐薬品性に優れ、フッ酸洗浄が可能なので、常にクリーンに保てる、⑤真空中でも、高温下でも放出ガスが極めて少ない、などである。新しく開発した「ベスベルSCP-5000」の特徴は、表4.4-2に示すように、「ベスベルSP-1」に比較して、機械的強度や硬度、剛性が高く、また寸法安定性や耐摩耗性、耐薬品性、耐酸化性が優れることである<sup>2)</sup>。「Vespel」は半導体製造プロセス用の部材として有用であるが、これは先に述べた特徴の他に、純度が高く、デバイスに悪影響を与える不純物が極めて少ないことや、硬度がセラミックや石英よりも軟らかく、ウェハーやガラスにダメージを与えない

表4.4-2 「ベスベルSCP-5000」の特性<sup>2)</sup>

| 組成  | SCP-5000         | SP-1             |
|---|------------------|------------------|
|   | 特性値              | 特性値              |
| 引っ張り強さ (kg/cm <sup>2</sup> )<br>23℃<br>260℃   | 1,360<br>534     | 878<br>422       |
| 引っ張り破断伸び (%)<br>23℃<br>260℃                   | 4.0<br>14.0      | 7.5<br>7.0       |
| 圧縮強さ (kg/cm <sup>2</sup> )<br>1% 変形<br>10% 変形 | 441<br>2095      | 253<br>1356      |
| 圧縮弾性率 (kg/cm <sup>2</sup> )                   | 36,300           | 24,600           |
| 表面硬さ (ロッキングスケール)                              | 84               | 48-54            |
| 線膨張係数 (10 <sup>-5</sup> cm/cm/℃)              | 3.8              | 5.0              |
| 吸水率 (%)<br>23℃ 24時間平面                         | < 0.10           | 0.24             |
| 片面線抗率 (Ω)                                     | 10 E 15          | 10 E 15          |
| 体積抵抗率 (Ω・cm)                                  | 10 E 16          | 10 E 16          |
| 誘電率<br>10 E4 Hz<br>10 E6 Hz                   | 3.44<br>3.42     | 3.64<br>3.55     |
| 誘電正接<br>10 E4 Hz<br>10 E6 Hz                  | 0.0021<br>0.0012 | 0.0038<br>0.0034 |

表4.1-2 高耐熱性フィルムの特性比較<sup>6, 7)</sup>

| 項 目                 | 単 位  | デュポン      |  | 宇部興産       |            | 鍾淵化学               |  | 三菱化成               |  | 日 東 電 工    |            | 三菱樹脂      |  | 東燃石化                  |  | 三井化学   |  | 住友化学  |  | 三井化学   |        |
|---------------------|--|-----------|--|------------|------------|--------------------|--|--------------------|--|------------|------------|-----------|--|-----------------------|--|--------|--|-------|--|--------|--------|
|                     |  | カプトン      |  | ユービレックス    |            | アピカル               |  | ノバックス              |  | ニットミッド U   |            | スペリオ UT   |  | PAA                   |  | レダルス   |  | スカエセル |  | レダルス   |        |
|                     |  | Hタイプ      |  | R          | S          | AH                 |  |                    |  | Film U     | Film N     | (PEK)     |  | (ポリパラベン酸)             |  |        |  | (PES) |  |        | (PEEK) |
| ガラス転移温度             | ℃  | (400)     |  | 285        | >500       | (400)              |  | 350                |  | 290        | なし         | 216       |  | 290                   |  | 250    |  | 225   |  | 250    | 143    |
| 熱収縮率 (250℃, 30 min) | %  | 0.3       |  | 2h 0.18    | 2h 0.07    | 0.15               |  | 2h 0.16            |  | 0.11       | 0.10       | 230℃ 0.2  |  | 260℃ 0.35             |  |        |  |       |  |        |        |
| 線膨張率                | $\times 10^{-6} \text{cm/cm/}^\circ\text{C}$ | 2.0       |  | 1.5        | 0.8        | 2.1                |  | 1                  |  | 2.0        | 2.3        | 4.9       |  | 4.2                   |  |        |  |       |  |        |        |
| 比熱                  | cal/g/°C                                     | 0.261     |  | 0.26       | 0.27       | 0.26               |  |                    |  |            |            | 0.3~0.32  |  |                       |  |        |  |       |  |        |        |
| 引張強さ (25℃)          | kg/mm <sup>2</sup>                           | 17.6      |  | 25         | 40         | 21.5               |  | 33                 |  | 22.0       | 20.0       | 11        |  | 11.2                  |  | 12     |  | 9     |  | 13     |        |
| " (200℃)            | "  | 12.0      |  | 20         | 300℃ 22    | 12.0               |  | 19                 |  |            |            |           |  | 3.9                   |  |        |  |       |  |        |        |
| 5%伸長時応力 (25℃)       | "  | 9.1       |  | 12         | 26         | 10                 |  | 21                 |  | 12.0       | 7.5        |           |  |                       |  |        |  |       |  |        |        |
| " (200℃)            | "  | 6.0       |  | 6          | 300℃ 9     | 6                  |  | 10                 |  |            |            |           |  |                       |  |        |  |       |  |        |        |
| 伸び率 (25℃)           | %  | 70        |  | 130        | 30         | 70                 |  | 40                 |  | 75         | 75         | 100       |  | 10                    |  | 110    |  | 100   |  | 100    |        |
| " (200℃)            | "  | 90        |  | 190        | 300℃ 48    | 92                 |  | 55                 |  |            |            |           |  | 5                     |  |        |  |       |  |        |        |
| 引張弾性率 (25℃)         | kg/mm <sup>2</sup>                           | 302       |  | 380        | 900        | 350                |  | 700                |  | 310        | 280        | 300       |  | 211                   |  | 310    |  | 260   |  | 300    |        |
| " (200℃)            | "  | 183       |  | 210        | 300℃ 350   | 182                |  | 390                |  |            |            |           |  | 141                   |  |        |  |       |  |        |        |
| 引裂き強さ(エルバンDレブ)      | g/mm <sup>2</sup>                            | 320       |  | 750        | 330        | 320                |  | 500                |  | 20         | 20         | 18        |  | 20                    |  | 2100   |  | 900   |  | 1400   |        |
| 増裂抵抗(グレーブ)          | kg/mm <sup>2</sup>                           | 20.1      |  | 40         | 23         | 19                 |  |                    |  |            |            |           |  | 0.33                  |  |        |  |       |  |        |        |
| 摩擦係数(フィルム/フィルム)     |  | 0.42      |  | 0.4        | 0.4        | 0.4                |  | 1                  |  |            |            |           |  |                       |  |        |  |       |  |        |        |
| 絶縁耐力 (25℃)          | kV/mm  | 276       |  | 276        | 268        | 275                |  | 296                |  | 320        | 320        |           |  | 220                   |  | 280    |  | 260   |  | 250    |        |
| " (200℃)            | "  | 220       |  | 280        | 268        | 210                |  | 250                |  |            |            |           |  |                       |  |        |  |       |  |        |        |
| 誘電率 (1kHz)          |  | 3.5       |  | 3.5        | 3.5        | 3.0                |  | 2.98               |  | 34         | 3.3        | 3.5       |  | 3.4                   |  | 3.1    |  | 3.7   |  | 3.1    |        |
| 誘電正接 (1kHz)         |  | 0.003     |  | 0.0014     | 0.0013     | 0.0021             |  | 0.0007             |  | 0.0020     | 0.0020     | 0.0013    |  | 0.0040                |  | 0.0009 |  | 0.014 |  | 0.0047 |        |
| 体積抵抗率               | $\Omega \cdot \text{cm}$                     | $10^{18}$ |  | $10^{17}$  | $10^{17}$  | $5 \times 10^{17}$ |  | $4 \times 10^{18}$ |  | $10^{17}$  | $10^{17}$  | $10^{17}$ |  | $5 \times 10^{18}$    |  |        |  |       |  |        |        |
| 表面抵抗率               | $\Omega$                                     | $10^{18}$ |  | $>10^{16}$ | $>10^{16}$ | $1 \times 10^{18}$ |  | $5 \times 10^{18}$ |  | $>10^{16}$ | $>10^{16}$ |           |  |                       |  |        |  |       |  |        |        |
| 密度                  | g/mm <sup>3</sup>                            | 1.42      |  | 1.39       | 1.47       | 1.42               |  | 1.38               |  | 1.40       | 1.42       | 1.27      |  | 1.36                  |  | 1.33   |  | 1.37  |  | 1.30   |        |
| 屈折率                 |  | 1.78      |  |            |            |                    |  | 1.75               |  |            |            |           |  |                       |  |        |  |       |  |        |        |
| 吸水率 (24h)           | %  | 2.9       |  | 1.3        | 1.2        | 2.7                |  | 48h 2.4            |  | 1.3        | 2.1        | 0.25      |  | 125 $\mu\text{m}$ 2.8 |  | 0.24   |  | 0.53  |  | 0.13   |        |
| 吸湿率 (50%/RH)        | "  | 1.3       |  | 1.0        | 0.8        | 1.2                |  | 0.98               |  | 2.0        | 2.2        |           |  | 4.7                   |  |        |  |       |  |        |        |
| 温度膨張率 (cm/cm/% RH)  | $\times 10^{-6}$                             | 2.2       |  | 2.2        | 1.1        | 2.1                |  | 1                  |  |            |            |           |  |                       |  |        |  |       |  |        |        |

表4.4-1 主なポリイミド成形品の特性<sup>1)</sup>

| 用 目       | 単 位                              | デ ュ ポ ン                             | 日 東 電 工              | 三 菱 電 機                         | 化 成              | 住 友 化 学          | EPL              | 東 芝 ケミカル | 日 本 ポリイミド          | 東 洋 電 機           |         |
|-----------|----------------------------------|-------------------------------------|----------------------|---------------------------------|------------------|------------------|------------------|----------|--------------------|-------------------|---------|
|           |                                  |                                     |                      |                                 |                  |                  |                  |          |                    | TI-1500           | TI-2500 |
| 熱 的 性 質   | ガラス転位温度                          | SP-1                                | ニップミッド M             | トーロン                            | PI-2080          | スミカ PAI          | ウルテム             | イミダロイ    | キネル                | T(ポリマー)           |         |
|           | 熱膨張率                             |                                     | M-100                | 4203 L                          |                  | M7000            | 1000             | KIR-30   | 5514               | TI-1500           |         |
|           | 熱伝導度                             |                                     |                      |                                 |                  |                  |                  |          |                    | TI-2500           |         |
|           | 比 熱                              |                                     |                      |                                 |                  |                  |                  |          |                    | GF                |         |
| 機 械 的 性 質 | 熱変形温度 (18.6 kg/cm <sup>2</sup> ) | ナチュラル                               | ナチュラル                | TiO <sub>2</sub> 3%<br>PTFE0.5% | ナチュラル            | ナチュラル            | ナチュラル            | ナチュラル    | GF50%              | GF                |         |
|           | 引張強さ (23°C)                      | (400)                               |                      | (PAI)                           |                  | (PAI)            | (PEH)            | (フレイミッド) | (フレイミッド)           | (熱硬化PAI) (フレイミッド) |         |
|           | 引張率 (23°C)                       | 4.4                                 | 5.5                  | 4.0                             | 310              | 4.6              | 217              | 7        | 1.3                | 2.5               |         |
|           | 熱伝導率 (23°C)                      | 0.295                               | 0.345                | 0.33                            | 5.0              | 0.367            | 5.6              |          | 0.31               | 0.3               |         |
| 電 的 性 質   | 比 熱                              | 0.27                                |                      |                                 |                  |                  | 0.19             |          |                    | >300              |         |
|           | 熱変形温度 (18.6 kg/cm <sup>2</sup> ) | -360                                |                      | 274                             | 270-280          |                  | 200              |          | 330                | >300              |         |
|           | 引張強さ (23°C)                      | 875                                 | 990                  | 1,900                           | 1,200            | 950              | 1,070            |          | 450                | 850               |         |
|           | 引張率 (23°C)                       | 420                                 | 250°C 570            | 530                             | 290°C 310        | 640              | 60               |          | 250°C 400          | 250°C 550         |         |
| 機 械 的 性 質 | 熱膨張率 (23°C)                      | 7.5                                 | 7.3                  | 12                              | 10               | 6.5              | 60               |          |                    | 1.2               |         |
|           | 熱伝導率 (23°C)                      | 7.0                                 | 250°C 7.0            | 22                              | -                | 12.5             |                  |          |                    | 0.5               |         |
|           | 比 熱                              | 1,330                               | 1,400                | 2,160                           | 1,970            | 1,890            | 1,480            |          | 1,500              | 1,400             |         |
|           | 熱変形温度 (23°C)                     | 770                                 | 250°C 18.1           | 760                             | 250°C 350        | 900              | 200°C 870        |          | 250°C 1,250        | 250°C 900         |         |
| 電 的 性 質   | 比 熱                              | 31.5                                | 31.1                 | 46.7                            | 35.2             | 42               | 33.7             |          | 140                | 103               |         |
|           | 熱膨張率 (23°C)                      | 17.5                                | 18.1                 | 30.3                            | 298°C 11.3       | 25               | 200°C 28.5       |          | 200°C 105          | 250°C 70          |         |
|           | 熱伝導率 (23°C)                      | 10%以下                               | 1,950                | >3,100                          | 2,000            | 2,690            | 1,430            |          | 2,400              | 2,200             |         |
|           | 比 熱                              | 24.5                                | 24.2                 | 31.5                            | 20.7             | 27               | 29.6             |          |                    | 2,700             |         |
| 機 械 的 性 質 | 熱膨張率 (23°C)                      | 8.1                                 |                      | 13.8                            | 7.9              | 2.0              | 5                |          | 30                 | 4                 |         |
|           | 熱伝導率 (23°C)                      | 3.55                                | 1kHz 3.5             | 3.3                             | 1kHz 3.42        |                  | 1kHz 3.15        |          | 4.5                | 3.9               |         |
|           | 比 熱                              | 0.0034                              | 0.002                | 0.009                           | 0.0018           |                  | 0.0013           |          | 0.017              | 0.009             |         |
|           | 熱膨張率 (23°C)                      | 22                                  | 1.4×10 <sup>-6</sup> | 23.6                            | 23               | 10 <sup>-6</sup> | 10 <sup>-6</sup> |          | 18                 | 20                |         |
| 電 的 性 質   | 熱伝導率 (1MHz)                      | 10 <sup>-6</sup> ~10 <sup>-10</sup> |                      | 10 <sup>-6</sup>                | 10 <sup>-6</sup> | 10 <sup>-6</sup> | 10 <sup>-6</sup> |          | 1×10 <sup>-6</sup> | 10 <sup>-6</sup>  |         |
|           | 比 熱                              | 10 <sup>-6</sup> ~10 <sup>-10</sup> |                      | 10 <sup>-6</sup>                | 10 <sup>-6</sup> | 10 <sup>-6</sup> | 10 <sup>-6</sup> |          | 10 <sup>-6</sup>   | 10 <sup>-6</sup>  |         |
|           | 熱膨張率 (23°C)                      | 1.43                                | 1.41                 | 1.40                            | 1.4              | 1.41             | 1.27             |          | 1.7                | 1.73              |         |
|           | 比 熱                              | E45~48                              |                      | E91                             | E99              | M117             | M109             |          | M118               | M120              |         |
| 機 械 的 性 質 | 熱膨張率 (23°C)                      | M92~102                             | 48 b 0.6             | 0.28                            | 0.25             | 0.21             | 0.25             |          | 0.5                | 0.3               |         |
|           | 比 熱                              | 0.24                                |                      |                                 |                  |                  |                  |          |                    | 0.40              |         |
|           | 熱膨張率 (23°C)                      |                                     |                      |                                 |                  |                  |                  |          |                    |                   |         |
|           | 比 熱                              |                                     |                      |                                 |                  |                  |                  |          |                    |                   |         |

Table 4. 1-2 Comparison of Characteristics of Highly Heat Resistant Films 6.7)

| Item  | Unit  | Du Pont |         | Ube Machinery |       | KANEKA  |      | Mitsubishi Chemical |           | Nitto Denko |        | Mitsubishi Plastics |                    | Tonen General |  | Mitsui Chemical |  | Sumitomo Chemical |        | Mitsui Chemical |  |
|---|---|---------|---------|---------------|-------|---------|------|---------------------|-----------|-------------|--------|---------------------|--------------------|---------------|--|-----------------|--|-------------------|--------|-----------------|--|
|   |   | Kapton  |         | Upilex        |       | Apical  |      | Nobax               |           | Nitto Mid U |        | Superio UT          |                    | PAA           |  | Reglus          |  | Sumika Excel      |        | Pictrex         |  |
|   |   | H Type  | R       | S             | AH    |         |      |                     |           | Film U      | Film N | (PET)               | (Polyaniline Acid) |               |  |                 |  | (PES)             | (PEEK) |                 |  |
| Glass-Transition Temperature                  | °C  | (400)   | 285     | >500          | (400) | 350     | 290  | No                  | 216       | 290         | 250    | 225                 | 143                |               |  |                 |  |                   |        |                 |  |
| Coefficient of Heat Shrinkage (250°C, 30 min) | %   | 0.3     | 2h 0.18 | 2h 0.07       | 0.15  | 2h 0.16 | 0.11 | 0.10                | 230°C 0.2 | 260°C 0.35  |        |                     |                    |               |  |                 |  |                   |        |                 |  |
| Coefficient of Linear Expansion               | $\times 10^{-5} \text{ cm/cm/}^\circ\text{C}$ | 2.0     | 1.5     | 0.8           | 2.1   | 1       | 2.0  | 2.3                 | 4.9       | 4.2         |        |                     |                    |               |  |                 |  |                   |        |                 |  |
| Specific Heat                                 | cal/g/°C                                      | 0.261   | 0.26    | 0.27          | 0.26  |         |      |                     | 0.3~0.32  |             |        |                     |                    |               |  |                 |  |                   |        |                 |  |
| Tensile Strength (25°C)                       | kg/mm <sup>2</sup>                            | 17.6    | 25      | 40            | 21.5  | 33      | 22.0 | 20.0                | 11        | 11.2        | 12     | 9                   | 13                 |               |  |                 |  |                   |        |                 |  |
| Tensile Strength (200°C)                      | "   | 12.0    | 20      | 300°C 22      | 12.0  | 19      |      |                     |           | 3.9         |        |                     |                    |               |  |                 |  |                   |        |                 |  |
| Stress at 5% Elongation (25°C)                | "   | 9.1     | 12      | 26            | 10    | 21      | 12.0 | 7.5                 |           |             |        |                     |                    |               |  |                 |  |                   |        |                 |  |
| Stress at 5% Elongation (200°C)               | "   | 6.0     | 6       | 300°C 9       | 6     | 10      |      |                     |           |             |        |                     |                    |               |  |                 |  |                   |        |                 |  |
| Coefficient of Extension (25°C)               | %   | 70      | 130     | 30            | 70    | 40      | 75   | 75                  | 100       | 10          | 110    | 100                 | 100                |               |  |                 |  |                   |        |                 |  |
| Coefficient of Extension (200°C)              | "   | 90      | 190     | 300°C 48      | 92    | 55      |      |                     |           | 5           |        |                     |                    |               |  |                 |  |                   |        |                 |  |
| Coefficient of Elasticity (25°C)              | kg/mm <sup>2</sup>                            | 302     | 380     | 900           | 350   | 700     | 310  | 280                 | 300       | 211         | 310    | 260                 | 300                |               |  |                 |  |                   |        |                 |  |
| Coefficient of Elasticity (200°C)             | "   | 183     | 210     | 300°C 350     | 182   | 390     |      |                     |           | 141         | 2100   | 900                 | 1400               |               |  |                 |  |                   |        |                 |  |
| Tearing Strength(Elmendorf)                   | g/mm <sup>2</sup>                             | 320     | 750     | 330           | 320   | 500     |      |                     |           |             |        |                     |                    |               |  |                 |  |                   |        |                 |  |
| End Tear Drag (Graves)                        | kg/mm <sup>2</sup>                            | 20.1    | 40      | 23            | 19    |         | 20   | 20                  | 18        | 20          |        |                     |                    |               |  |                 |  |                   |        |                 |  |
| Coefficient of Dynamic Friction (Film / Film) |   | 0.42    | 0.4     | 0.4           | 0.4   | 1       |      |                     |           | 0.33        |        |                     |                    |               |  |                 |  |                   |        |                 |  |



Table 4. 4-1 Characteristics of Major Polyimide Moldings<sup>1)</sup>

| Item  | Unit                             | Du Pont               | Nitto Denko | Mitsubishi Chemical               | Sumitomo Chemical | EPL     | Toshiba Chemical    | Nippon Polyimide    | Toray                  |                     |
|---|----------------------------------|-----------------------|-------------|-----------------------------------|-------------------|---------|---------------------|---------------------|------------------------|---------------------|
|   |                                  | VESPEL                | Nitto Mid M | Tolon                             | Sumika PAI        | ULTEM   | Imidaroy            | Kinel               | TI Polymer             |                     |
|   |                                  | SP-1                  | M-100       | 4203 L                            | M 7000            | 1000    | KIR-30              | 5514                | TI-1500                | TI-2500             |
|   |                                  | Natural               | Natural     | TiO <sub>2</sub> 3 %<br>PTFE0.5 % | Natural           | Natural | Natural             | GF 50 %             | GF                     | GF                  |
|   |                                  | (Cutting<br>Operated) |             | (PAI)                             | (PAI)             | (PEI)   | (Maleimide<br>Type) | (Maleimide<br>Type) | Thermo-<br>setting PAI | (Maleimide<br>Type) |
| Glass-Transition Temperature                              | °C                               | (400)                 |             | (260)                             | 310               | 217     |                     |                     |                        |                     |
| Coefficient of Thermal Expansion                          | $\times 10^{-3}$ cm/cm·°C        | 4.4                   | 5.5         | 4.0                               | 5.0               | 5.6     | 7                   | 1.3                 | 2.5                    | 2.6                 |
| Heat Conductivity   | kcal/m·h·°C                      | 0.295                 | 0.345       | 0.33                              |                   | 0.19    |                     | 0.31                | 0.3                    | 0.3                 |
| Specific Heat   | kcal/kg·°C                       | 0.27                  |             |                                   |                   |         |                     |                     |                        |                     |
| Heat Distortion Temperature<br>(18.6 kg/cm <sup>2</sup> ) | °C                               | ~350                  |             | 274                               | 270-280           | 200     |                     | 330                 | >300                   | >300                |
| Tensile Strength (23°C)                                   | kg/cm <sup>2</sup>               | 875                   | 990         | 1,900                             | 1,200             | 1,070   |                     | 450                 | 850                    | 670                 |
| Tensile Strength (260°C)                                  |                                  | 420                   | 250°C 570   | 530                               | 290°C 310         |         |                     | 250°C 400           | 250°C 550              | 250°C 400           |
| Elongation at Break (23°C)                                | %                                | 7.5                   | 7.3         | 12                                | 10                | 60      |                     |                     | 1.2                    | 0.5                 |
| Elongation at Break (260°C)                               |                                  | 7.0                   | 250°C 7.0   | 22                                | —                 |         |                     |                     |                        |                     |
| Bending Strength (23°C)                                   | kg/cm <sup>2</sup>               | 1,330                 | 1,400       | 2,160                             | 1,970             | 1,480   |                     | 1,500               | 1,400                  | 1,400               |
| Bending Strength (260°C)                                  |                                  | 770                   | 250°C 18.1  | 760                               | 290°C 350         |         | 200°C 870           | 250°C 1,250         | 250°C 900              | 250°C 720           |
| Bending Modulus (23°C)                                    | $\times 10^3$ kg/cm <sup>2</sup> | 31.5                  | 31.1        | 46.7                              | 35.2              | 33.7    | 35.7                | 140                 | 103                    | 66                  |
| Bending Modulus (260°C)                                   |                                  | 17.5                  | 18.1        | 30.3                              | 290°C 11.3        |         | 200°C 28.5          | 200°C 105           | 250°C 70               | 250°C 8             |
| Compression Strength                                      | kg/cm <sup>2</sup>               | 10 % Strain 1,351     | 1,950       | >3,100                            | 2,000             | 1,430   | 2,080               | 2,400               | 2,200                  | 2,700               |
| Compression Modulus                                       | $\times 10^3$ kg/cm <sup>2</sup> | 24.5                  | 24.2        | 31.6                              | 20.7              | 29.6    |                     |                     |                        |                     |
| Impact Strength(Izod, Notched)                            | kg·cm/cm                         | 8.1                   |             | 13.8                              | 7.9               | 5       | 2-3                 | 30                  | 4                      | 2                   |